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January 2015

FDMS86202ET120

N-Channel Shielded Gate PowerTrench® MOSFET 120 V, 102 A, 7.2 m Ω

Features

- Extended T_J rating to 175°C
- Shielded Gate MOSFET Technology
- Max $r_{DS(on)} = 7.2 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 13.5 \text{ A}$
- Max $r_{DS(on)} = 10.3 \text{ m}\Omega$ at $V_{GS} = 6 \text{ V}$, $I_D = 11.5 \text{ A}$
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

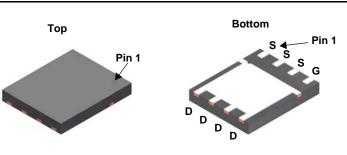


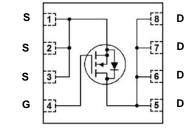
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

Application

■ DC-DC Conversion





Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parame	eter		Ratings	Units	
V_{DS}	Drain to Source Voltage			120	V	
V_{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	102		
	-Continuous	T _C = 100 °C	(Note 5)	72	A	
ID	-Continuous	T _A = 25 °C	(Note 1a)	13.5	_ A	
	-Pulsed		(Note 4)	538		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	600	mJ	
D	Power Dissipation	T _C = 25 °C		187	W	
P_{D}	Power Dissipation	T _A = 25 °C	(Note 1a)	3.3	VV	
T_J , T_{STG}	Operating and Storage Junction Temperat	ture Range		-55 to +175	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.8	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	45	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86202ET	FDMS86202ET120	Power 56	13 "	12 mm	3000 units

©2015 Fairchild Semiconductor Corporation FDMS86202ET120 Rev. C1

Electrical Characteristics $T_J = 25$ °C unless otherwise noted

Parameter

Off Characteristics								
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	120			V		
$\Delta BV_{DSS} \over \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		103		mV/°C		
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 96 V, V _{GS} = 0 V			1	μΑ		
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA		

Test Conditions

Min

Тур

Max

Units

On Characteristics

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \mu A$	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-10		mV/°C
r _{DS(on)}		V _{GS} = 10 V, I _D = 13.5 A		6.0	7.2	
		$V_{GS} = 6 \text{ V}, I_D = 11.5 \text{ A}$		8.1	10.3	mΩ
		V _{GS} = 10 V, I _D = 13.5 A,T _J = 125 °C		10.9	13.2	
g _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 13.5 A		44		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 60 V, V _{GS} = 0 V, f = 1 MHz		3275	4585	pF
C _{oss}	Output Capacitance			460	644	pF
C _{rss}	Reverse Transfer Capacitance			17	30	pF
R_g	Gate Resistance		0.1	0.9	2.7	Ω

Switching Characteristics

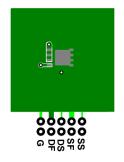
t _{d(on)}	Turn-On Delay Time			21	33	ns
t _r	Rise Time	$V_{DD} = 60 \text{ V}, I_{D} = 13.$.5 A,	8.75	17.5	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10 V, R _{GEN} =	: 6 Ω	27.2	44	ns
t _f	Fall Time			6.1	12.2	ns
Q_q	Total Gate Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$		45	64	nC
Q_q	Total Gate Charge	$V_{GS} = 0 \text{ V to } 6 \text{ V}$	V _{DD} = 60 V,	29	41	nC
Q_{gs}	Gate to Source Charge		I _D = 13.5 A	14.3		nC
Q_{qd}	Gate to Drain "Miller" Charge			9.5		nC

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Dioge Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 2.1 \text{ A}$ (Note 2)	0.69	1.2	V
		$V_{GS} = 0 \text{ V}, I_S = 13.5 \text{ A}$ (Note 2)	0.76	1.3	
t _{rr}	Reverse Recovery Time	I _F = 13.5 A, di/dt = 100 A/μs	79	127	ns
Q _{rr}	Reverse Recovery Charge	T _F = 13.5 A, di/dt = 100 A/μs	140	224	nC

Notes:

^{1.} R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.



a) 45 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 115 °C/W when mounted on a minimum pad of 2 oz copper.

- 2. Pulse Test: Pulse Width < 300 μs , Duty cycle < 2.0%.
- 3. E_{AS} of 600 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 20 A, V_{DD} = 120 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 65 A.
- 4. Pulse Id please refer to Fig.11 SOA curve for detail.
- 5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

Typical Characteristics T_J = 25 °C unless otherwise noted

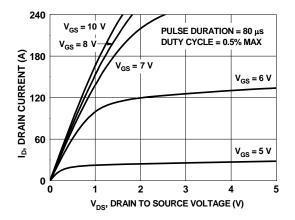


Figure 1. On Region Characteristics

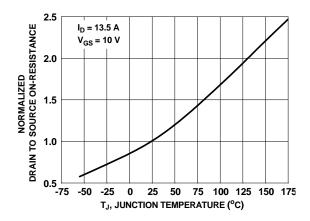


Figure 3. Normalized On Resistance vs Junction Temperature

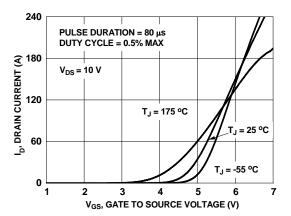


Figure 5. Transfer Characteristics

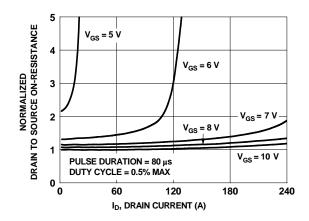


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

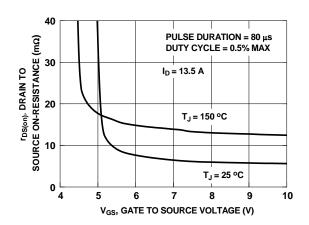


Figure 4. On-Resistance vs Gate to Source Voltage

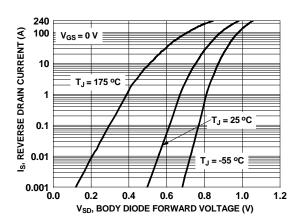


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25$ °C unless otherwise noted

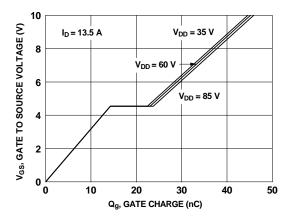
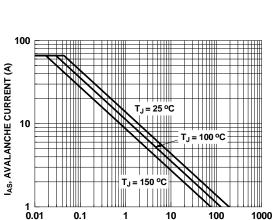


Figure 7. Gate Charge Characteristics



10

 t_{AV} , TIME IN AVALANCHE (ms)

1000

Figure 9. Unclamped Inductive Switching Capability

0.1

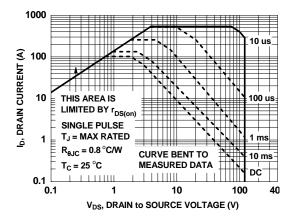


Figure 11. Forward Bias Safe **Operating Area**

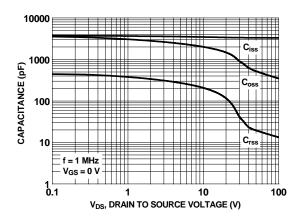


Figure 8. Capacitance vs Drain to Source Voltage

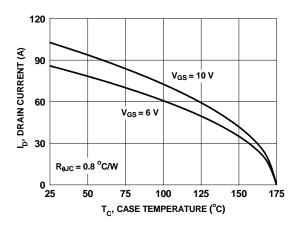


Figure 10. Maximum Continuous Drain **Current vs Case Temperature**

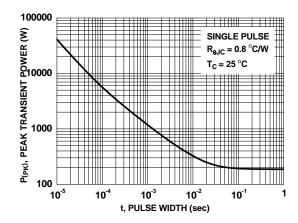


Figure 12. Single Pulse Maximum **Power Dissipation**

Typical Characteristics $T_J = 25$ °C unless otherwise noted

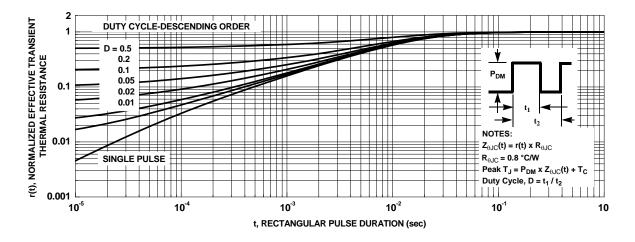
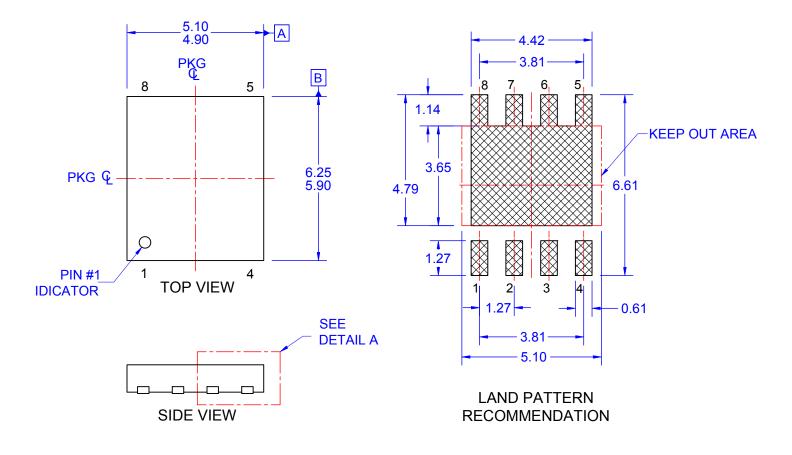
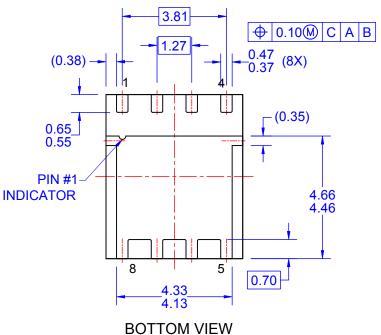
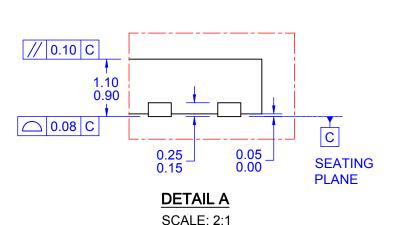


Figure 13. Junction-to-Ambient Transient Thermal Response Curve







NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. AA,
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- E) IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.
- F) DRAWING FILE NAME: PQFN08JREV3.



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